

High Speed Model


3D AXI

AUTOMATED X-RAY INSPECTION

TR7600 SIII SERIES

 Ultra-High Speed
3D CT X-Ray Inspection

 Ultimate Resolution AXI
for Large Boards

 Smart Programming with
Robust Algorithms

1200 x 660
mm mm
Large Board Support

High Speed Inspection

Smart Factory Ready

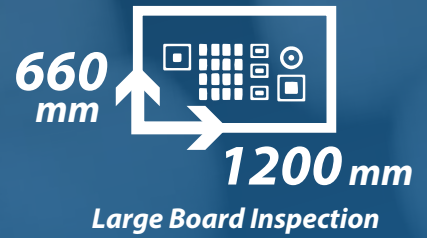


TR7600 SIII SERIES



High Performance 3D AXI for Large PCB Assemblies

The TR7600 SIII series is TRI's hallmark inline line scan 3D AXI, with CT capabilities specialized, designed for the inspection of larger board sizes, up to 1200 mm x 660 mm. The TR7600 SIII series delivers industry's fastest high resolution imaging performance and great image quality in the industry's most advanced automatic X-ray inspection.

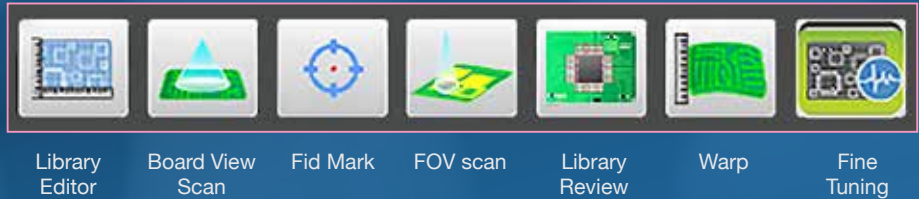


A perfect fit for multiple industries.



Smart Programming

The new 3D AXI intuitive software helps set up inspection programs based on CAD data. The TR7600 SIII series is equipped with TRI's extensive smart component library, reducing engineer workload and minimizing production downtime.



High Resolution Design for Maximum Defect Detection

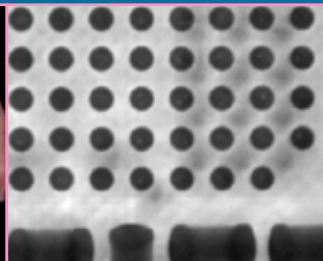
The TR7600 SIII series enhanced 3D inspection with planar CT imaging can recreate a complete 3D model of each solder joint, enabling clear analysis of shape irregularities, head-in pillow and voiding problems. Vertical cross-section CT images help with reliable visual review of borderline and buried solder joints.



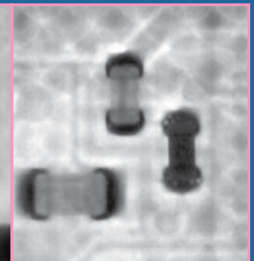
BGA short / open 3D CT Inspection



THT 3D CT Inspection



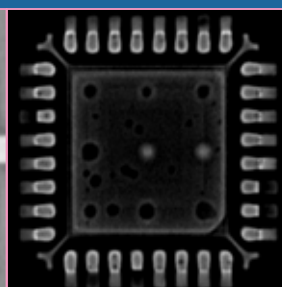
PoP soldering Inspection



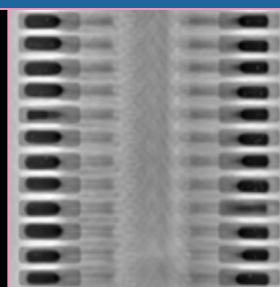
Chip Inspection



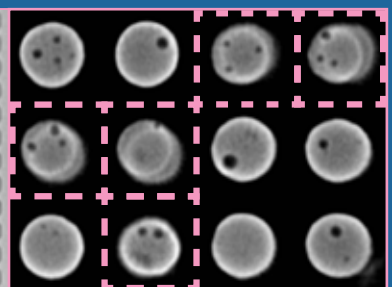
Void Inspection of LED



QFN 3D CT Inspection



DIMM Connector Inspection



BGA HiP Defect

Board Warpage Control

The AXI solution uses multiple laser sensors to measure PCB assembly deformations and adjusts component inspection parameters to compensate for the board warpage.



Top of the Line Repair Station

The AXI repair station collects a wide range of inspection data and offers statistical feedback that enhances the efficiency of the inspection process.

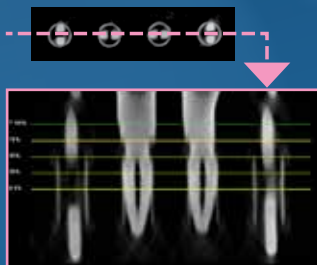


Ease of Maintenance

The high-reliability robust platform and advanced automatic/scheduled calibration with detail reporting ensure ease of maintenance.



PressFit Connector Inspection



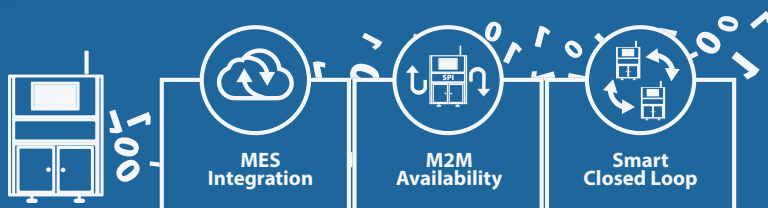
Press-fit Cross Section Inspection



Press-fit 3D CT Inspection

TRI AXI solutions can accurately inspect and detect missing, insufficient penetration and askew in press-fit connectors. The press-fit connector inspection can individually detect defects in individual slices and viewed in high detail as 3D CT images. The automotive and telecommunications industries greatly benefit from an accurate press-fit inspection as their robust boards are commonly present in them (e.g., communication servers and automotive sensors).

Big Data Ready



Boost your factory intelligence and optimize your production line by easily integrating big data analytics from your solutions. TRI's smart factory test and inspection solutions promote full traceability and data exchange, by generating big data for your MES applications, essential for optimizing your production your yield rate, enabling the connected factory.

YMS 4.0 - Smart Review System

Yield Management System (YMS) 4.0 reduce operator re-inspection with the smart review system module. The intelligent defect review module is an algorithm-based solution that offers real time reporting to improve defect management and yield rate.



YMS 4.0 - Smart Monitoring

TRI's smart factory solutions allow operators to aggregate information from individual systems for statistical analysis of production line defect rates, reviewing and fine-tuning inspection results, and identifying component defect trends and emerging production issues.



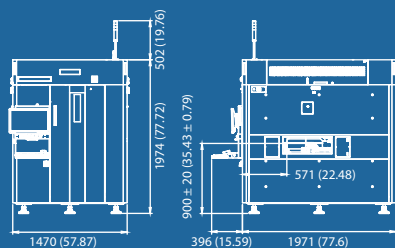
Production Analysis

Centralized Inspection Center

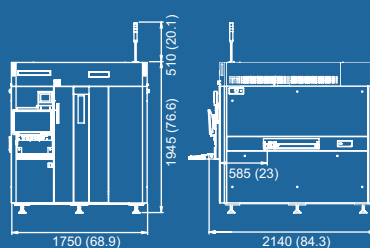
Real Time SPC Trends

Model	TR7600 SIII	TR7600LL SIII	TR7600TL SIII
Camera	Ultra-High Speed Line-Scan CCD Cameras (3 or 5 Units)		
X-ray Source	130 kV Max (User Adjustable)		
Imaging System	7 μm, 10 μm, 15 μm, 20 μm		10 μm, 15 μm, 20 μm, 25 μm
Imaging Resolution (User Selectable)			
Inspection Method	2D, 2.5D, 3D Slicing, Planar CT (Optional)		
Inspection Functions	Missing, Misalignment, Tombstone, Billboard, Tantalum Polarity, Rotation and Floating		
Component Defects	Insufficient/Excess Solder, Bridging, Open, Solder Ball, Non-Wetting, Void and Lifted Lead		
Solder Joint Defects			
X-Y-Z-Axis Control	High-Precision Ballscrew + AC-Servo Controller		
X-Y-Z Axis Accuracy	1 μm		
Max PCB Size	Standard 510 x 460 mm (20.08 x 18.11 in.)	510 x 660 mm (20.08 x 25.98 in.)	610 x 660 mm (24.02 x 25.98 in.)
PCB Thickness	0.6 - 7 mm (0.02 - 0.28 in.)		
PCB Transport Height	880 - 920 mm (34.65 - 36.22 in.)		
Max PCB Weight	12 kg (26.46 lb)		
PCB Carrier / Fixing	Step Motor Driven / Pneumatic Clamping		
Clearance	25 μm	N/A	50 mm (1.97 in.)
	20 μm		50 mm (1.97 in.)
	15 μm		30 mm (1.18 in.)
	10 μm		15 mm (0.59 in.)
	7 μm	7 mm (0.28 in.)	N/A
	25 μm	N/A	55 mm (2.17 in.)
	20 μm		70 mm (2.76 in.)
Bottom	15 μm		70 mm (2.76 in.)
	10 μm		70 mm (2.76 in.)
	7 μm	70 mm (2.76 in.)	N/A
Edge		3 mm (0.12 in.) or 5 mm (0.2 in.)	
Weight	3850 kg (8487.8 lb)	4500 kg (9920.8 lb)	4750 kg (10,471.96 lb)
Power Requirement	200 - 240 VAC single phase, 50/60 Hz, 4 kVA	200 - 240 VAC, Three Phase, 50 / 60 Hz, 7 kVA. Optional: 346 - 416 VAC Three Phase Transformer	
Air Requirement	72 psi - 87 psi (5 - 6 bar)		
Optional Features	Barcode Scanner, Repair Station, Offline Editor, Yield Management System (YMS 4.0), CAD Converter and CT Imaging		

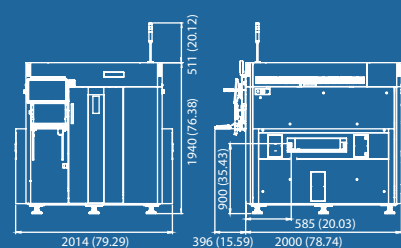
Unit: mm (in.)



TR7600 SIII



TR7600LL SIII



TR7600TL SIII

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TRI 德律 TRI INNOVATION

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